

24/03/2022

Lecture 30

Surface Tension undergoes a role reversal

- 1) Before rupture it tries to stabilize the film and opposes hole formation
- 2) After rupture  $\rightarrow$  it now favors hole growth!  
=

Instability Test on 7<sup>th</sup> April, 2022 THU

$\rightarrow$  30 min / 25 marks MCQ.

## Typical Dewatering Experiments: -

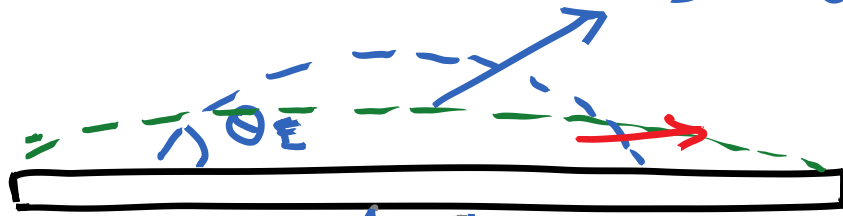
(1) you need a ultra thin Liquid film:

How to create polymer thin film, which are very thin  
( $\sim 10 \text{ nm}$  to  $100 \text{ nm}$ ).

→ Spin Coating → Take a polymer  
dissolve it in a solvent.

(It's a good solvent + Moderately High  
vap pressure).

Some amount of the Polymer Soln.



→ Substrate to be coated.



Shaft can rotate at speeds between 500 RPM to 10,000 RPM. \*

- ① As rotation starts, there is excess centrifugal force ~~on~~ acting on the drop along the contact line →

Drop spreads.

(1-3 seconds)

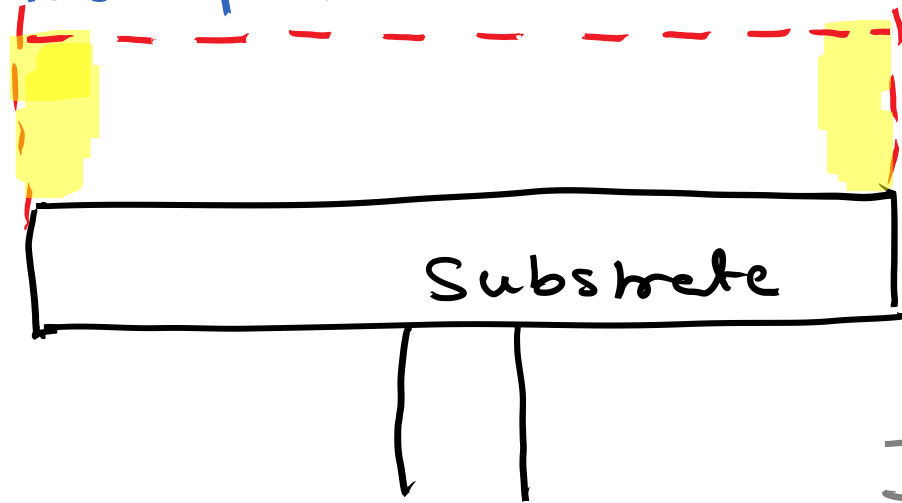
- ② The advancing meniscus → reaches the edge of sample / substrate. → Major part of the liquid is thrown out



**Video courtesy: Dr Nandini Bhandaru, BITS Hyderabad**



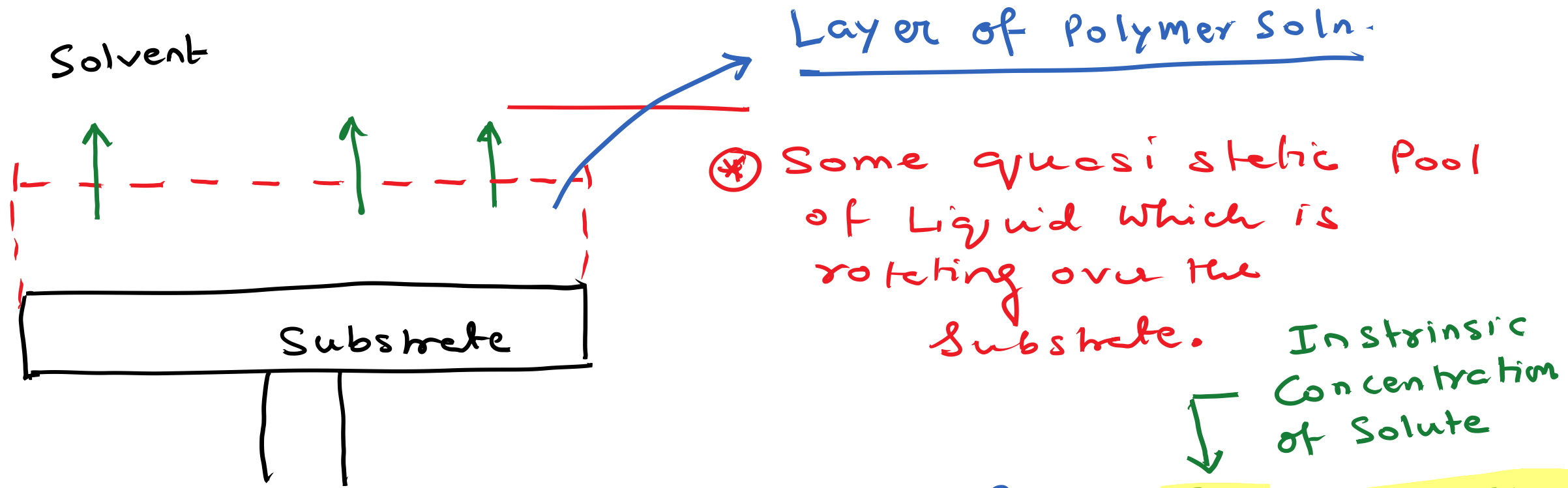
No splashing after that



\* Some quasi static Pool of Liquid which is rotating over the Substrate.

It is possible to Spin Coat on a Non Wettable Surface As well.

\* If Non wettable  $\rightarrow$  Apply Higher Force / Higher RPM.



What is the consequence of Evaporation? →  $C_{ni}$  gradually increases.

When does film deposition start?

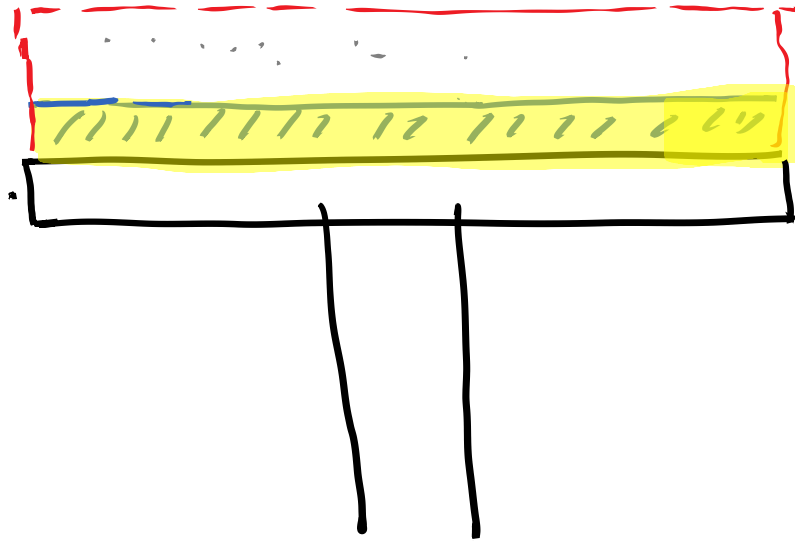
$$\underline{C_{ni} \approx C_n^*}$$

$C_n^* \rightarrow$  Saturation Concentration

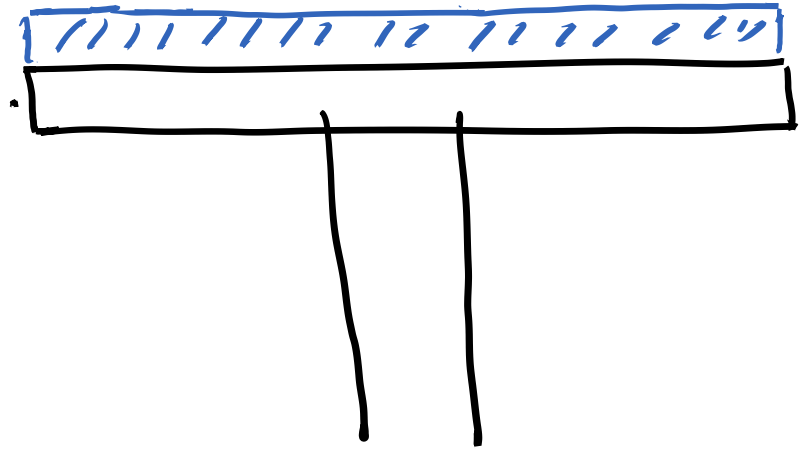
(Progressive Reduction in the thk of the Solution Layer)

↳ Solute starts to phase separate, and deposit over the surface forming the Film.

\* Why a low evaporating/  
Low Vap pr. Solvent is  
not used !!



Film  
formation



Later stage

Final stage

Spin Coating gives extremely uniform  
film thickness -

Stop  
Rotation

Time of Rotation  $\rightarrow$   $>$  Time Reqd

by the time almost all excess solvent  
is evaporated.